PRODUCT / PROCESS CHANGE INFORMATION

| | | 1. PCI basic data |
|----------------------|----------------|--|
| 1.1 Company | life.augmented | STMicroelectronics International N.V |
| 1.2 PCI No. | | AMS/23/14220 |
| 1.3 Title of PCI | | Products Lines Qualification in UTL3 (L099, U1MD, MY13/MY15/MY16 and MY1P/MY05). |
| 1.4 Product Category | , | Pls refer to the Products List. |
| 1.5 Issue date | | 2023-07-18 |

| | 2. PCI Team |
|---------------------------|-------------------------|
| 2.1 Contact supplier | |
| 2.1.1 Name | NEMETH KRISZTINA |
| 2.1.2 Phone | +49 89460062210 |
| 2.1.3 Email | krisztina.nemeth@st.com |
| 2.2 Change responsibility | |
| 2.2.1 Product Manager | Domenico ARRIGO |
| 2.1.2 Marketing Manager | Fabio CHELLI |
| 2.1.3 Quality Manager | Alessandro PLATINI |

| 3. Change | | |
|--------------|---|----------------------------|
| 3.1 Category | 3.2 Type of change | 3.3 Manufacturing Location |
| | Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Assembly site (SOP 2617) | UTL1 and UTL3 |

| | 4. Description of change | |
|---|--------------------------|---|
| | Old | New |
| 4.1 Description | | Assy Process in UTL3 and FT in UTL1 except for L099 and U1MD which are tested in CLB. |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact | |

| | 5. Reason / motivation for change |
|----------------------|---|
| 5.1 Motivation | The qualification will assure capacity increase on the impacted products. |
| 5.2 Customer Benefit | CAPACITY INCREASE |

| | 6. Marking of parts / traceability of change |
|-----------------|--|
| 6.1 Description | New FGs |

| | 7. Timing / schedule |
|-------------------------------------|----------------------|
| 7.1 Date of qualification results | 2023-10-27 |
| 7.2 Intended start of delivery | 2023-11-10 |
| 7.3 Qualification sample available? | Upon Request |

| | 8. Qualification / Validation | | |
|--|-------------------------------|---------------|--|
| 8.1 Description | | | |
| 8.2 Qualification report and qualification results | | Issue Date | |

| | 9. Attachments (additional documentations) |
|--------------------------|--|
| 14220 Public product.pdf | |

| 10. Affected parts | | |
|------------------------|-------------------------|--------------------------|
| 10. 1 Current | | 10.2 New (if applicable) |
| 0.1.1 Customer Part No | 10.1.2 Supplier Part No | 10.1.2 Supplier Part No |
| | STSPIN32F0 | |
| | STSPIN32F0601QTR | |
| | STSPIN32F0ATR | |
| | STSPIN32F0B | |
| | STSPIN32F0BTR | |

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